



TAYCHIPST

GLASS PASSIVATED GENERAL PURPOSE RECTIFIERS

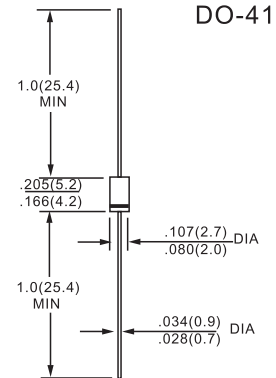
1N4001G-1N4007G,BY133G
50V-1000V
1.0A

FEATURES :

- * Glass passivated chip
- * High current capability
- * High reliability
- * Low reverse current
- * Low forward voltage drop

MECHANICAL DATA :

- * Case : DO-41 Molded plastic
- * Epoxy : UL94V-O rate flame retardant
- * Lead : Axial lead solderable per MIL-STD-202, Method 208 guaranteed
- * Polarity : Color band denotes cathode end
- * Mounting position : Any
- * Weight : 0.339 gram



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25 °C ambient temperature unless otherwise specified.
Single phase, half wave, 60 Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

RATING	SYMBOL	1N	1N	1N	1N	1N	1N	1N	BY	UNIT
		4001G	4002G	4003G	4004G	4005G	4006G	4007G	133G	
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	1300	Volts
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	910	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	1300	Volts
Maximum Average Forward Current 0.375"(9.5mm) Lead Length Ta = 75 °C	I _{F(AV)}	1.0								Amp.
Peak Forward Surge Current 8.3ms Single half sine wave Superimposed on rated load (JEDEC Method)	I _{FSM}	30								Amps.
Maximum Forward Voltage at I _F = 1.0 Amp.	V _F	1.0								Volts
Maximum DC Reverse Current Ta = 25 °C at rated DC Blocking Voltage Ta = 100 °C	I _R	5.0								μA
	I _{R(H)}	50								μA
Typical Junction Capacitance (Note1)	C _J	8								pF
Typical Thermal Resistance (Note2)	R _{θJA}	45								°C/W
Junction Temperature Range	T _J	- 65 to + 175								°C
Storage Temperature Range	T _{STG}	- 65 to + 175								°C

Notes : (1) Measured at 1.0 MHz and applied reverse voltage of 4.0VDC
(2) Thermal resistance from Junction to Ambient at 0.375" (9.5mm) Lead Lengths, P.C. Board Mounted.



FIG. 1 - FORWARD CURRENT DERATING CURVE

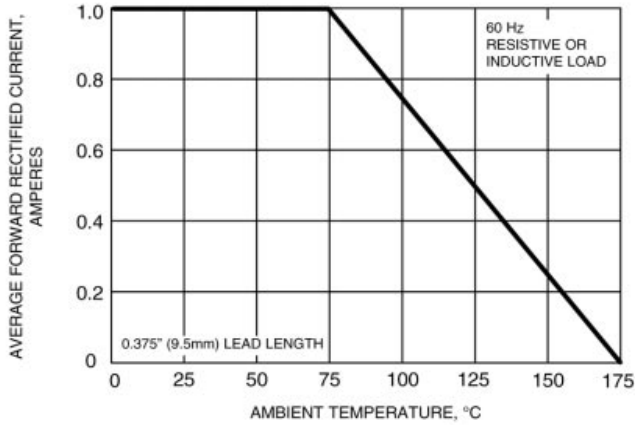


FIG. 2 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

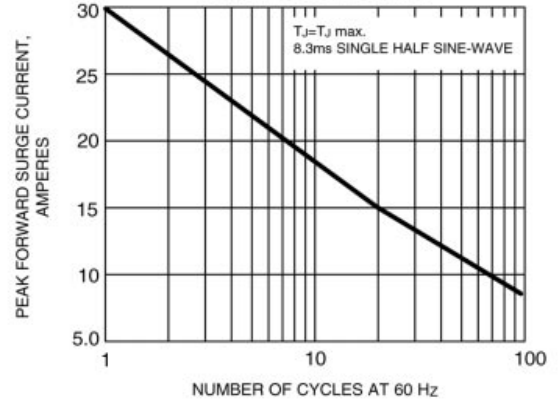


FIG. 3 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

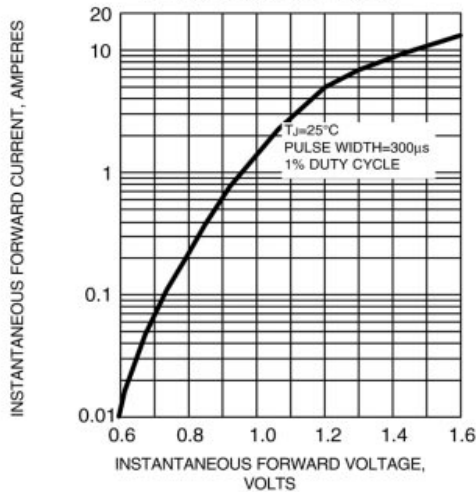


FIG. 4 - TYPICAL REVERSE CHARACTERISTICS

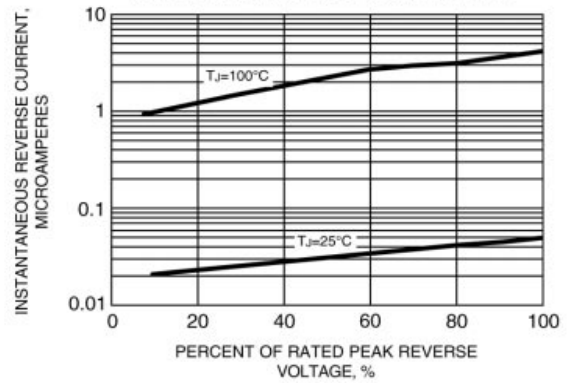


FIG. 5 - TYPICAL JUNCTION CAPACITANCE

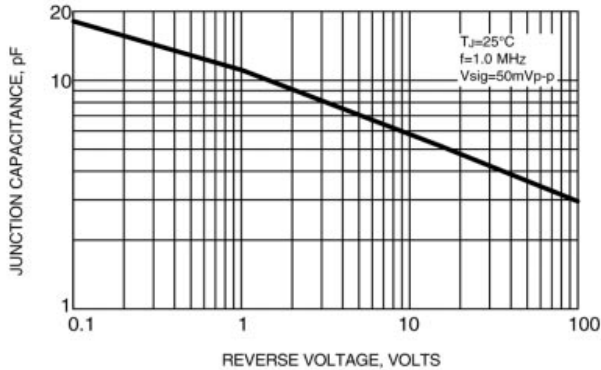


FIG. 6 - TYPICAL TRANSIENT THERMAL IMPEDANCE

